

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







25.00 0.30 ◆ 0.2 X Y Z Tous droits strictement reserves. Reproduction ou communication a des tiers interdate sous quelque forme que ce soit sons autorisation ecrite du propietaire. Propriete de CFCI. Droits de reproduction FCI. 20 9 90 SCALE 2.000 3. 0 27.20 38.20 В 34.20 (17.10)13.75 25 40, 31.70 SCALE 2.000 tomerance unless otherwise specified .X ± .5 .XX ± .30 0° ± 2° Ø1.50 1 0.25 (2.00) angles tolerance projection A ММ www.fciconnect.com ASME YI4.5 $\oplus \Box$ FCI KENNY TAI 04/08/05 Product family Scale size A 4 date ecn no KENNY TAI 04/08/05 1.000 Spec ref T05-0186 08/31/05 04/08/05 T05-0186 KENNY TAI Material SEE NOTES ECN Appr PAUL WANG 04/08/05 34.20 Rev BELOW MOUNT, O STAND-OFF 10055262 gwb Α EXPRESSCARD HOST CONNECTOR catalog no 10055262 CUSTOMER sheet I of 2

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³PDM: Rev:A

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STATUS: Released ⁴ Printed: Sep 08, 2005

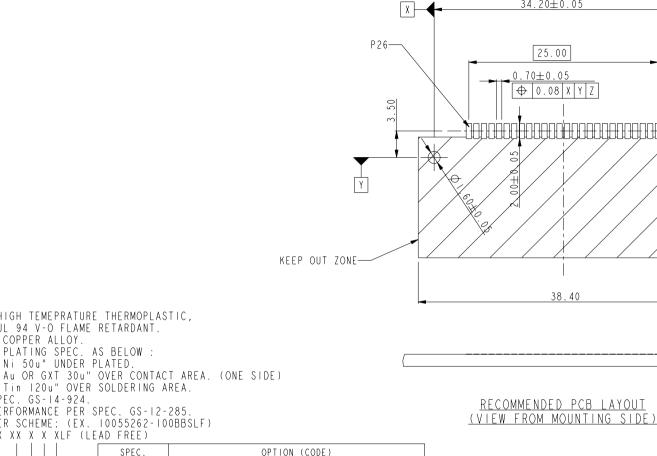
 34.20 ± 0.05

25.00 0.70 ± 0.05 ◆ 0.08 X Y

38.40

RECOMMENDED PCB LAYOUT





10055262-X XX X X XLF (LEAD FREE) SPEC. PACKING TRAY (S) TAPE & REEL (T) TUBE (P) HSG COLOR BLACK (B) NATURE (N) MOUNT SIDE BELOW (B) STAND-OFF 0 (00) PLATING GOLD (I) GXT (2)

5. ROHS COMPATIBLE PRODUCT SPECIFICATIONS

HOUSING: HIGH TEMEPRATURE THERMOPLASTIC, UL 94 V-O FLAME RETARDANT.

2. PACKING SPEC. GS-14-924. 3. PRODUCT PERFORMANCE PER SPEC. GS-12-285.

4. PART NUMBER SCHEME: (EX. 10055262-100BBSLF)

PLATING SPEC. AS BELOW: Ni 50u" UNDER PLATED.

Tin 120u" OVER SOLDERING AREA.

TERMINAL: COPPER ALLOY.

a-PLATING:

NOTES :

I. MATERIAL:

-"LF" MEANS THE PRODUCT IS LEAD-FREE, 2micro-meter MINIMUM MATTE TIN OVER I.27micro-meter MINIMUM NICKEL UNDERPLATE. b-MANUFACTURING PROCESS COMPATIBILITY.

-THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A REFLOW SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

Rev BELOW MOUNT, O STAND-OFF 10055262 EXPRESSCARD HOST CONNECTOR catalog no 10055262 CUSTOMER sheet 2 of 2

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SCALE 2.000

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